

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT3782742

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SHANGHAI LEXVU OPTO MICROELECTRONICS TECHNOLOGY CO., LTD.	02/25/2016

RECEIVING PARTY DATA

Name:	XI'AN YISHEN OPTOELECTRONICS TECHNOLOGY CO., LTD.
Street Address:	SUITE 204, YUANHU BUILDING, NO. 60 GREAT WESTERN ROAD, HIGH TECH NEW INDUSTRIAL PARK, HIGH TECH AREA
City:	XI'AN
State/Country:	CHINA
Postal Code:	710119

PROPERTY NUMBERS Total: 13

Property Type	Number
Application Number:	12411308
Application Number:	12435835
Application Number:	12613227
Application Number:	12622382
Application Number:	12629644
Application Number:	12683144
Application Number:	12698854
Application Number:	12793295
Application Number:	12885836
Application Number:	12873172
Application Number:	12965009
Application Number:	13540356
Application Number:	12821968

CORRESPONDENCE DATA

Fax Number: (703)621-7155

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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PATENT

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ATTORNEY DOCKET NUMBER: 0118/0207M

NAME OF SUBMITTER: JOE MCKINNEY MUNCY

SIGNATURE: /Joe McKinney Muncy/

DATE SIGNED: 03/14/2016

Total Attachments: 4

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PATENT ASSIGNMENT

THIS ASSIGNMENT is made this 25th day of February, 2016

BETWEEN:

- (1) SHANGHAI LEXVU OPTO MICROELECTRONICS TECHNOLOGY CO., LTD., a Chinese company having its place of business at Suite 501B, Building 5, No. 3000 Long Dong Ave., Zhangjiang Hi-Tech Park, Shanghai 201203, China (hereinafter referred to as "the Assignor");
- (2) XI'AN YISHEN OPTOELECTRONICS TECHNOLOGY CO., LTD., a Chinese company having its place of business at Suite 204, Yuanhu Building, No. 60 Great Western Road, High Tech New Industrial Park, High Tech Area, Xi'an 710119, China (hereinafter referred to as "the Assignee").

WHEREAS:

- (A) The Assignor is the proprietor of the patents/patent applications set out in the Schedule hereto (hereinafter referred to as "the Patents") relating to the inventions contained therein (hereinafter referred to as "the Inventions").
- (B) The Assignor has agreed to assign the Patents and the Inventions to the Assignee for the consideration set out below.

IT IS AGREED AS FOLLOWS:

1. In consideration of the sum of One Dollar (\$1.00) now paid to the Assignor by the Assignee (receipt of which is hereby acknowledged by the Assignor) the Assignor hereby assigns to the Assignee all right title and interest in the Patents and the Inventions referred to above, including all rights arising therefrom, including the right to file further applications in any country in respect of the Inventions, and including the right to bring proceedings for any previous infringement of the rights assigned by this Assignment.
2. The Assignor shall, at the expense of the Assignee, execute all such documents and do all such things as may reasonably be required for the Assignee (or the nominee of the Assignee) to enjoy the full benefit of the property and rights hereby assigned, including (if required to do so by the Assignee) applying for patents in the name of the Assignor.

IN WITNESS of which the parties have executed this Assignment the day and year first above written.

SCHEDULE

The Patents included in the assignment are the following:

Country	Title	Application No.	Application Date
US	INTEGRATED OPTO-ELECTRONIC DEVICE AND PORTABLE REFLECTIVE PROJECTION SYSTEM	12/411,308	March 25, 2009
US	METHOD FOR PROCESSING A THIN FILM MICRO DEVICE ON A SUBSTRATE	12/435,835	May 5, 2009
US	SPECIAL OPTICAL MODULATION ARRAY DEVICE AND A METHOD OF FABRICATING THE SAME	12/613,227	November 5, 2009
US	POLARIZING CUBE AND METHOD OF FABRICATING THE SAME	12/622,382	November 19, 2009
US	INTEGRATED PLANAR POLARIZING DEVICE AND METHODS OF FABRICATION	12/629,644	December 2, 2009
US	SINGLE-IMAGER PROJECTION ENGINE ASSEMBLY	12/683,144	January 6, 2010
US	TWDM ELEMENT, IMAGER, AND METHOD FOR TEMPORALLY AND SPATIALLY MODULATING BY USING THE SAME	12/698,854	February 2, 2010
US	METHOD OF ENCAPSULATING A WAFER LEVEL MICRODEVICE	12/793,295	June 3, 2010
US	LIQUID CRYSTAL IMAGER AND METHOD OF MAKING SAME	12/885,836	September 20, 2010
US	METHOD OF FABRICATING AND ENCAPSULATING MEMS DEVICES	12/873,172	August 31, 2010

US	TRI WAVELENGTH INTERFERENCE MODULATOR AND A METHOD FOR MODULATION	12/865,009	December 10, 2010
US	TRI WAVELENGTH DIFFRACTION MODULATOR AND A METHOD FOR MODULATION	13/540,356	July 2, 2012
US	POWER AMPLIFIER AND BRIDGE CIRCUIT IN POWER AMPLIFIER	12/821,968	June 23, 2010

Signed for and on behalf of)
the Assignor by)
Chang Wenfen Legal Manager)
(Name & Position))

Chang Wenfen Legal Manager
(Signature)

Signed for and on behalf of)
the Assignee by)
Chang Wenfen Legal Manager)
(Name & Position))

Chang Wenfen Legal Manager
(Signature)